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Cha	nges from Re	vision F (.	July 2012) to Rev	/isio	n F	SBAS486F –N	OVEM	BER 2009-REVI		2 <u>2016</u> age
					S41Bx9 and QFN to V					
• [Added Applications section, Device Information table, front-page figure, ESD Ratings table, Feature Description section, Device Functional Modes section, Programming section, Register Maps section, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section. Deleted Ordering Information table Changed Pin Functions table: changed title and format Added Added last row to Voltage applied to input pins section in Absolute Maximum Ratings table.								1 6	
(Changed <i>Temperature</i> parameters in <i>Absolute Maximum Ratings</i> table: changed format of <i>Temperature</i> section and changed maximum specifications for T _A and T _J									
	•				nmended Operating Co nmended Operating C					
	Deleted High-Performance Modes section from Recommended Operating Conditions table									
• (Changed conditions of Electrical Characteristics: General table from temperature to ambient temperature to ambient temperature									
. /	Added footnote 1 to Electrical Characteristics: ADS41B29, ADS41B49 table								. 10	
• (Changed conditions of Timing Requirements: LVDS and CMOS Modes table from temperature to ambient temperature 12								12	
	Added footnotes 6 and 7 to Timing Requirements: LVDS and CMOS Modes table									
	Added footnote 1 to Timing Requirements: Reset table									
	Changed title of Figure 13 and Figure 14 1									
• (Changed title of Figure 31 and Figure 32							. 19		
	Changed conditions of Table 6									
· A	Added Summary of High-Performance Modes section								40	
· C	Changed bit re	gisters to s	atisfy new standa	ard re	quirements					41
he c	datasheet i	number	will be chan	gin	 g.		_			-
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ADS41B29/ADS41B49								SBAS486F		
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Reason for Change:

To more accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this PCN:

None.

Product Affected:

ADS41B29IRGZ25	ADS41B29IRGZR	ADS41B29IRGZT	ADS41B49IRGZR
ADS41B49IRGZT			

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

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